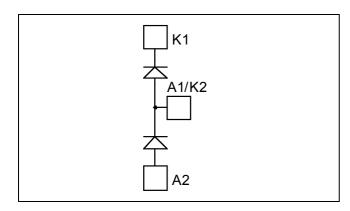


# Diode Phase leg Power Module

$$V_{RRM} = 1700V$$
  
 $I_{C} = 400A @ Tc = 55^{\circ}C$ 



### Application

- Anti-Parallel diode
- Uninterruptible Power Supply (UPS)
- Induction heating
- Welding equipment
- High speed rectifiers

#### **Features**

- Ultra fast recovery times
- Soft recovery characteristics
- High blocking voltage
- High current
- Low leakage current
- Very low stray inductance
  - Symmetrical design
  - M5 power connectors
- High level of integration

#### **Benefits**

- Outstanding performance at high frequency operation
- Low losses
- Low noise switching
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- RoHS Compliant

### Absolute maximum ratings

Symbol	Parameter			Max ratings	Unit
$V_R$	Maximum DC reverse Voltage			1700	V
$V_{RRM}$	Maximum Peak Repetitive Reverse Voltage			1700	V
$I_{F(AV)}$	Maximum Average Forward Current  Duty cycle = 50%	D . 1 . 500/	$T_c = 25$ °C	480	
		$T_c = 55$ °C	400	Δ	
I <sub>F(RMS)</sub>	RMS Forward Current			500	Λ
$I_{FSM}$	Non-Repetitive Forward Surge Current $T_j = 25$ °C			1500	

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

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## All ratings @ $T_j = 25$ °C unless otherwise specified

#### **Electrical Characteristics**

	Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$V_{\rm F}$	Diode Forward Voltage	$I_F = 400A$	$T_i = 25^{\circ}C$		2.2	2.5	V	
			$T_{i} = 125^{\circ}C$		2.1			
	Ţ	Maximum Reverse Leakage Current	V = 1700V	$T_i = 25^{\circ}C$			750	4
	$\mathbf{I}_{\mathrm{RM}}$	Waximum Reverse Leakage Current	$V_R = 1700V$	$T_{i} = 125^{\circ}C$			1000	μΑ

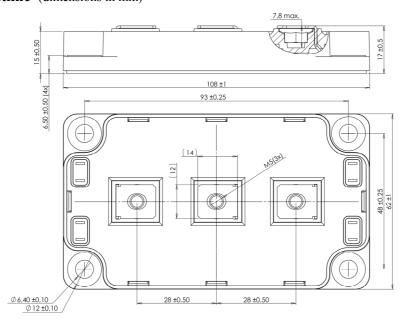
### **Dynamic Characteristics**

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
t <sub>rr</sub>	Reverse Recovery Time	$I_F = 400A$ $V_R = 900V$ $di/dt = 4000A/\mu s$	$T_j = 25^{\circ}C$		572		ns
			$T_{j} = 125^{\circ}C$		704		113
Q <sub>rr</sub>	Reverse Recovery Charge		$T_j = 25^{\circ}C$		80		- µС
			$T_{j} = 125^{\circ}C$		140		
$I_{RRM}$	Reverse Recovery Current		$T_j = 25^{\circ}C$		280		Α
			$T_j = 125$ °C		400		Α

### Thermal and package characteristics

Symbol	Characteristic		Min	Тур	Max	Unit	
$R_{thJC}$	Junction to Case Thermal Resistance					0.095	°C/W
$V_{ISOL}$	RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz			4000			V
$T_{\mathrm{J}}$	Operating junction temperature range		-40		150	°C	
$T_{STG}$	Storage Temperature Range			-40			125
$T_{\rm C}$	Operating Case Temperature			-40			100
Torque	Mounting torque	To heatsink	M6	3		5	N.m
		For terminals	M5	2		3.5	11.111
Wt	Package Weight					300	g

### SP6 Package outline (dimensions in mm)

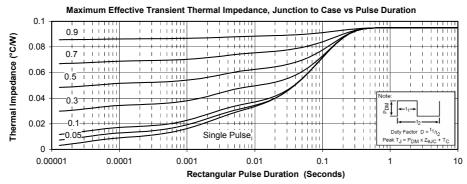


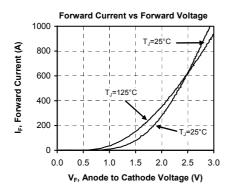
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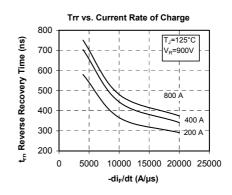
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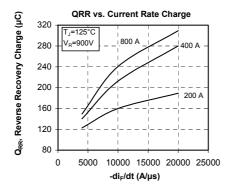


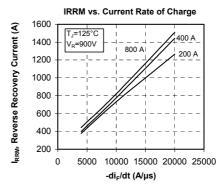
#### **Typical Performance Curve**

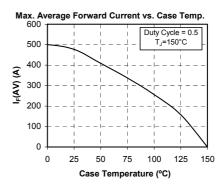














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